# G.B. TECHNICAL UNIVERSITY, LUCKNOW



**Syllabus** 

# 3<sup>rd</sup> & 4<sup>th</sup> Year

[Effective from session 2009-10]

- 1. B.Tech. Electronics Engg.
- 2. B.Tech. Electronics & Communication Engg.
- **3.** B.Tech. Electronics & Telecommunication Engg.

#### U.P. TECHNICAL UNIVERSITY, LUCKNOW Study and Evaluation Scheme B.Tech. Electronics Engineering, B.Tech. Electronics & Communication Engg., B.Tech. Electronics & Telecommunication Engg. (Also for B.Tech. Biomedical Engineering) [Effective from the session 2009-10]

YEAR 2 <sup>nd</sup> , SEMESTER-III										ER-III	
						<b>Evaluation Scheme</b>			ie	Subject Total	
S. No.	Course Code	SUBJECT	PERIODS		SESSIONAL EXAM.			ESE	Credit		
			L	Т	Р	СТ	ТА	Total		Total	
THEO	RY SUBJEC	TS									
1.	EHU-301/ EHU-302	Industrial Psychology/ Industrial Sociology	2	0	0	15	10	25	50	75	2
2.	EAS-301/ EOE-031- EOE-038	Mathematics III/ Science based open Elective**	3	1	0	30	20	50	100	150	4
3.	EEC-301	Fundamentals of Electronics Devices	3	1	0	30	20	50	100	150	4
4.	EEC-302	Digital Electronics	3	1	0	30	20	50	100	150	4
5.	EEC-303	Electromagnetic Field Theory	3	1	0	30	20	50	100	150	4
6.	EEC-304	Fundamentals of Network Analysis & Synthesis	3	1	0	30	20	50	100	150	4
7.	EHU-111	*Human Values & Professional Ethics	2	2	0	15	10	25	50	75	-
PRAC	TICAL/DES	IGN/DRAWING			•	•					
8	EEC-351	Electronics Engineering Lab I	0	0	2		20	20	30	50	1
9.	EEC-352	Digital Electronics Lab-I	0	0	2		20	20	30	50	1
10.	EEC-353	PCB & Electronics Workshop	0	0	2		10	10	15	25	1
11.	GP 301	General Proficiency	-	-	-	-	-	50	-	50	1
		Total	17	5	6	165	160	375	625	1000	26

\* Human Values & Professional Ethics will be offered as compulsory Audit Course for which passing marks are 40% in theory & 50% in aggregate. Students will be required to audit it within the period of their study. There will not be carry over facility for this course and a failure student will be required to repeat this course.

#### \*\* Science based open Elective

EOE031/EOE041 Introduction to soft computing (Neural network, Fuzzy logic and Genetic algorithm) EOE032/EOE042 Nano-sciences EOE033/EOE043 Laser systems and applications EOE034/EOE044 Space sciences EOE035/EOE045 Polymer science and technology EOE036/EOE046 Nuclear science EOE037/EOE047 Material science EOE038/EOE048 DISCRETE mathematics

(2)

#### U.P. TECHNICAL UNIVERSITY, LUCKNOW Study and Evaluation Scheme B.Tech. Electronics Engineering, B.Tech. Electronics & Communication Engg., B.Tech. Electronics & Tele Communication Engg. (Also for B.Tech. Biomedical Engineering) [Effective from the session 2009-10]

YEAR 2<sup>nd</sup>, SEMESTER-IV

							Evaluat	ion Scher			
S. No.	Course	SUBJECT	PE	PERIODS		S	SESSIONAL			Subject	edit
5.110.	Code	Code				EXAM.			ESE	Total	CĽ
			L	Т	Р	СТ	ТА	Total		Total	
THEO	RY SUBJEC	TS					•	•			
1.	EHU-402/	Industrial Sociology/Industrial	2	0	0	15	10	25	50	75	2
	EHU-401	Psychology									
2.	EOE-041-	Science based open Elective**/	3	1	0	30	20	50	100	150	4
	EOE-048/	Mathematics III									
	EAS-401										
3.	EEC-401	Electronic circuits	3	1	0	30	20	50	100	150	4
4.	EEC-402	Computer Architecture &	3	1	0	30	20	50	100	150	4
		Organization									
5.	EEC-403	Electronic Instrumentation and	3	1	0	30	20	50	100	150	4
		Measurements									
6.	EEC-404	Signals and Systems	3	1	0	30	20	50	100	150	4
7.	EHU-111	*Human Values & Professional	2	2	0	15	10	25	50	75	-
		Ethics									
PRAC	TICAL/DES	IGN/DRAWING				•		•			
8.	EEC-451	Electronics Engineering lab II	0	0	2		20	20	30	50	1
9	EEC-452	Digital Electronics Lab II	0	0	2		20	20	30	50	1
10	EEC-453	Measurement lab	0	0	2		10	10	15	25	1
11.	GP 401	General Proficiency	-	1-	-	-	-	50	-	50	1
		Total	17	5	6	165	160	375	625	1000	26

#### **\*\*Science based open Elective**

EOE031/EOE041 Introduction to soft computing (Neural network, Fuzzy logic and Genetic algorithm) EOE032/EOE042 Nano-sciences EOE033/EOE043 Laser systems and applications EOE034/EOE044 Space sciences EOE035/EOE045 Polymer science and technology EOE036/EOE046 Nuclear science EOE037/EOE047 Material science EOE038/EOE048 DISCRETE mathematics

# **Modified & Revised**

#### G.B. TECHNICAL UNIVERSITY, LUCKNOW Study and Evaluation Scheme B.Tech. Electronics Engineering, B.Tech. Electronics & Communication Engg., B.Tech. Electronics & Tele Communication Engg. [Effective from the session 2010-11]

YEAR 3<sup>rd</sup>, SEMESTER-V

						Evaluation Scheme			ne	e	
S. No.	Course Code	SUBJECT	PF	ERIC	DDS	S	ESSION EXAM	IAL [.	ESE	Subject	Credit
			L	Т	Р	СТ	ТА	Total		Total	•
THEORY SUBJECTS								·			
1	EEC 501	Integrated Circuits	3	1	0	30	20	50	100	150	4
2	EEC 502	Principles of Communications	3	1	0	30	20	50	100	150	4
3	EEC 503	Microprocessors	3	1	0	15	10	25	50	75	3
4	EEC 504	Antenna & Wave Propagation	3	1	0	15	10	25	50	75	3
5	EIC 501	Control Systems - I	3	1	0	30	20	50	100	150	4
6	EHU 501	Engineering and Managerial Economics	3	1	0	30	20	50	100	150	3
7	AUC 001	*Human Values & Professional Ethics	2	0	0	15	10	25	50	75	-
PRAC	TICAL/DES	IGN/DRAWING						·			
8.	EEC 551	Integrated circuits Lab	0	0	2		20	20	30	50	1
9.	EIC 551	Control Systems Lab	0	0	2		20	20	30	50	1
10.	EEC 552	Communication Lab- I	0	0	2		20	20	30	50	1
11.	EEC 553	Microprocessors Lab	0	0	2		20	20	30	50	1
12.	GP 501	General Proficiency	-	-	-	-	-	50	-	50	1
		Total	18	6	8	150	180	380	620	1000	26

# Modified

### **G.B. TECHNICAL UNIVERSITY, LUCKNOW**

**Study and Evaluation Scheme** 

B.Tech. Electronics Engineering, B.Tech. Electronics & Communication Engg.,

**B.Tech. Electronics & Tele Communication Engg.** 

[Effective from the session 2010-11]

YEAR 3<sup>rd</sup>, SEMESTER-VI

						Evaluation Scheme			ne	Subject	
S. No.	Course Code	SUBJECT		PERIODS		SESSIONAL EXAM.		ESE	Credi		
			L	Т	Р	СТ	TA	Total		Totai	•
THEORY SUBJECTS											
1.	EHU 601	Industrial Management	3	0	0	30	20	50	100	150	3
2.	EEC 601	Digital communication	3	1	0	30	20	50	100	150	4
3.	EEC 602	Digital Signal Processing	3	1	0	30	20	50	100	150	4
4.	EEC 603	Microwave Engineering	3	1	0	30	20	50	100	150	4
5.	EEC 604	Introduction to Electric Drives	3	1	0	15	10	25	50	75	3
6.		Departmental Elective-I**	3	1	0	15	10	25	50	75	3
7.	AUC 001	*Human Values & Professional Ethics	2	0	0	15	10	25	50	75	-
PRAC	TICAL/DES	IGN/DRAWING									
8.	EEC 654	Seminar	0	0	2		50	50	-	50	1
9.	EEC 651	Communication Lab – II	0	0	2		20	20	30	50	1
10.	EEC 653	CAD of Electronics Lab	0	0	2		20	20	30	50	1
11.	EEC 652	DSP Lab	0	0	2		20	20	30	50	1
12.	GP 601	General Proficiency	-	-	-	-	-	50	-	50	1
		Total	18	5	8	150	210	410	590	1000	26

#### LIST OF ELECTIVES:

#### Elective – I\*\*

- 1. EEC 011 Analog signal processing Data Structures
- 2. EEC 012
- 3. EEC 013 Advance Semiconductor Devices
- 4. EIC 601 Microcontroller

# Syllabus third semester:

#### THEORY SUBJECTS

EEC 301 FUNDAMENTALS OF ELECTRONICS DEVICES						
Unit	Торіс	Chapter/	Proposed			
		Section	Lectures			
Ι	Crystal Properties and charge Carriers in Semiconductors:					
	Elemental and compound semiconductor materials, crystal lattice	1.1 to 1.2				
	structure,	31 to $31$	8			
	Bonding forces and energy bands in solids, charge carriers in	5.1 10 5.4	0			
	semiconductors, carrier concentrations, drift of carriers in electric and					
	magnetic fields.					
II	Excess Carriers in Semiconductors: Optical absorption, luminescence,	4.1 to 4.3 and	8			
	carrier life time and photo conductivity, diffusion of carriers.	4.4.1 to 4.4.4				
III	Junction Properties: Equilibrium conditions, biased junctions, steady	5.2 to 5.5				
	state conditions, reverse bias break down, transient and AC conditions.	57	10			
	Metal semiconductor junctions.	5.7				
IV	Transistors: Metal-semiconductor-field-effect-transistors (MESFET),	6.3.1 to $6.3.2$ ,				
	Metal-insulator-semiconductor-field-effect-transistors (MISFEI), Metal	651  to  652				
	oxide semiconductor field effect transistor (MOSFEI): Construction,	0.0.1 10 0.0.2	6			
	Dipolar junction transistors: Fundamentals of DIT energian	7.1 to 7.2				
	amplification with BITs					
V	Some special devices:					
v	Photodiodes photo detectors solar cell light emitting diodes	81 821				
	semiconductor lasers, light emitting materials.	8.2.3, 8.3, 8.4;				
	Tunnel Diode: degenerate semiconductors,	10.1				
	IMPATT diode;	10.2	8			
	The transferred electron mechanism: The GUNN diode.	10.3.1, 10.3.2				
	P-N-P-N diode, semiconductor controlled rectifier (SCR), bilateral	11.1 10 11.5				
	devices: DIAC, TRIAC, IGBT.					
Text Bo	ok: B. G. Streetman and S. Banerjee "Solid state electronics devices", 5 <sup>th</sup> Ed	ition, PHI.				
<b>Reference Books:1.</b> Alok Dutta, "Semiconductor Devices and circuits", Oxford University Press.						
	2. Donaid A Ineaman, Semiconductor Physics and Devices Basic Principles" 3 <sup>rd</sup> Ed TMH India					

EEC 302 DIGITAL ELECTRONICS					
Unit	Торіс	Chapter/ Section	Proposed number of Lectures		
Ι	Digital system and binary numbers: Signed binary numbers, binary codes, cyclic codes, error detecting and correcting codes, hamming codes. Floating point representation Gate-level minimization: The map method up to five variable, don't care conditions, POS simplification, NAND and NOR implementation, Quine Mc-Clusky method (Tabular method).	1.6, 1.7, 7.4 3.1 to 3.7, 3.10	8		
II	Combinational Logic: Combinational circuits, analysis procedure, design procedure, binary adder-subtractor, decimal adder, binary multiplier, magnitude comparator, decoders, encoders, multiplexers	4.1 to 4.11	8		
III	Synchronous Sequential logic: Sequential circuits, storage elements: latches, flip flops, analysis of clocked sequential circuits, state reduction and assignments, design procedure. Registers and counters: Shift registers, ripple counter, synchronous counter, other counters.	5.1 to 5.5, 5.7 to 5.8 6.1 to 6.5	8		
IV	Memory and programmable logic: RAM, ROM, PLA, PAL. Design at the register transfer level: ASMs, design example, design with multiplexers.	7.1 to 7.3, 7.5 to 7.7 8.4, 8.5, 8.10	8		
V	Asynchronous sequential logic: Analysis procedure, circuit with latches, design procedure, reduction of state and flow table, race free state assignment, hazards.	9.1 to 9.7	8		
<b>Text Book:</b> M. Morris Mano and M. D. Ciletti, "Digital Design", 4 <sup>th</sup> Edition, Pearson Education					
Referen	ce Books: 1. Hill & Peterson, "Switching Circuit & Logic Design", Wiley.				

	EEC 303 ELECTROMAGNETIC FIELD THEORY		310
Unit	Topic	Chapter/	Proposed
		Section	number of
T	Coordinate systems and transformation: Cartesian coordinates circular	2 1 to 2 4	Lectures
1	cylindrical coordinates spherical coordinates	2.1 10 2.4	
	Vector calculus: Differential length area and volume line surface and	3 1 to 3 8	
	volume integrals del operator gradient of a scalar divergence of a	5.1 10 5.0	6
	vector and divergence theorem curl of a vector and Stoke's theorem		
	Laplacian of a scalar.		
II	Electrostatics: Electrostatic fields, Coulombs law and field intensity,	to 4.9	
	Electric field due to charge distribution, Electric flux density, Gausses's		
	Law – Maxwell's equation, Electric dipole and flux lines, energy density		
	in electrostatic fields.		
	Electric field in material space: Properties of materials, convection and	5.1 to 5.6, 5.8,	10
	conduction currents, conductors, polarization in dielectrics, dielectric	5.9	10
	constants, continuity equation and relaxation time, boundary condition.		
	Electrostatic boundary value problems: Poission's and Laplace's	6.1, 6.2, 6.4 to	
	equations, general procedures for soling Poission's or Laplace's	6.6	
	equations, resistance and capacitance, method of images.		
III	Magnetostatics: Magneto-static fields, Biot-Savart's Law, Ampere's	7.1 to 7.7	
	circuit law, Maxwell's equation, application of ampere's law, magnetic		
	flux density- Maxwell's equation, Maxwell's equation for static fields,		
	Magnetic scalar and vector potential.	91 to $90$	8
	magnetic torque and moment a magnetic dinale magnetization in	8.1 10 8.9	
	magnetic torque and moment, a magnetic dipole, magnetization m		
	magnetic energy		
IV	Wayes and applications: Maxwell's equation Faraday's Law	9.1 to 9.5	
	transformer and motional electromotive forces, displacement current.	<i>y vo y</i>	
	Maxwell's equation in final form.		
	Electromagnetic wave propagation: Wave propagation in lossy	10.1, 10.3 to	8
	dielectrics, plane waves in lossless dielectrics, plane wave in free space,	10.8	
	plain waves in good conductors, power and the pointing vector,		
	reflection of a plain wave in a normal incidence.		
V	Transmission lines: Transmission line parameters, Transmission line	11.1 to 11.6	
	equations, input impedance, standing wave ratio and power, The Smith		8
	chart, Some applications of transmission lines.		
Text Bo	ok: M. N. O. Sadiku, "Elements of Electromagnetics", 4 <sup>th</sup> Ed, Oxford Unive	rsity Press.	
Referen	ce Books: W. H. Hayt and J. A. Buck, "Electromagnetic field theory", 7 <sup>th</sup> Ec	I., TMH.	

EEC 304 FUNDAMENTAL OF NETWORK ANALYSIS & SYNTHESIS					
Unit	Торіс	Chapter/ Section	Proposed number of Lectures		
Ι	Signal analysis, complex frequency, network analysis, network synthesis General characteristics and descriptions of signals, step function and associated wave forms, The unit impulse Introduction to network analysis, network elements, initial and final conditions, step and impulse response, solution of network equations	1.1 to 1.4 2.1 to 2.3 5.1 to 5.5	10		
II	Review of Laplace transforms, poles and zeroes, initial and final value theorems, The transform circuit, Thevenin's and Norton's theorems, the system function, step and impulse responses, the convolution integral. Amplitude and phase responses. Network functions, relation between port parameters, transfer functions using two port parameters, interconnection of two ports.	7.1 to 7.5 8.1 9.1 to 9.4	8		
III	Hurwitz polynomials, positive real functions. Properties of real immittance functions, synthesis of LC driving point immittances, properties of RC driving point impedances, synthesis of RC impedances or RL admittances, properties of RL impedances and RC admittances.	10.2,10.3 11.1 to 11.5	8		
IV	Properties of transfer functions, zeroes of transmission, synthesis of $Y_{21}$ and $Z_{21}$ with 1 $\Omega$ terminations.	12.1 to 12.3	6		
V	Introduction to active network synthesis Active Network Synthesis	Material available on UPTU website & 8.7 (Text Book 2)	8		
Text Bo 1. 2. Poforor	<ul> <li>Text Book:</li> <li>1. Franklin F. Kuo, "Network Analysis and synthesis", 2<sup>nd</sup> Edition, Wiley India Pvt Ltd.</li> <li>2. Behrouz Peikari, "Fundamentals of Network Analysis &amp; synthesis", Jaico Publishing House, 2006.</li> </ul>				

#### LABORATORY

#### EEC 351 ELECTRONICS ENGINEERING LAB I

**Objective:** To attain expertise in lab equipment handling and understanding the basic devices, their properties, characteristics in detail. Along with their practical usage in the circuit

- 1. **Study of lab equipments and components:** CRO, Multimeter, Function Generator, Power supply- Active, Passive Components & Bread Board.
- 2. **P-N Junction Diode**: Characteristics of PN Junction diode-Static and dynamic resistance measurement from graph.
- 3. **Applications of PN junction diode**: Half & Full wave rectifier- Measurement of Vrms, Vdc, and ripple factor-use of filter- ripple reduction (RC Filter)-Clipper & Clamper
- 4. **Properties of junctions** Zener diode characteristics. Heavy doping alters the reverse characteristics. Graphical measurement of forward and reverse resistance.
- 5. **Application of Zener diode:** Zener diode as voltage regulator. Measurement of percentage regulation by varying load resistor.
- 6. **Characteristic of BJT**: BJT in CB and CE configuration- Graphical measurement of h parameters from input and output characteristics. Measurement of A<sub>v</sub>, A<sub>I</sub>, R<sub>o</sub> and R<sub>i</sub> of CE amplifier with potential divider biasing.
- 7. **Characteristic of FET**: FET in common source configuration. Graphical measurement of its parameters gm, rd & m from input and output characteristics.
- 8. **Characteristic** of silicon-controlled rectifier.
- 9. To plot V-I Characteristics of DIAC.
- 10. To draw V-I characteristics of TRIAC for different values of Gate Currents.

#### EEC 352 DIGITAL ELECTRONICS LAB

Objective: To understand the digital logic and create various systems by using these logics.

- 1. Introduction to digital electronics lab- nomenclature of digital ICs, specifications, study of the data sheet, concept of  $V_{cc}$  and ground, verification of the truth tables of logic gates using TTL ICs.
- 2. Implementation of the given Boolean function using logic gates in both SOP and POS forms.
- 3. Verification of state tables of RS, JK, T and D flip-flops using NAND & NOR gates.
- 4. Implementation and verification of Decoder/De-multiplexer and Encoder using logic gates.
- 5. Implementation of 4x1 multiplexer using logic gates.
- 6. Implementation of 4-bit parallel adder using 7483 IC.
- 7. Design, and verify the 4-bit synchronous counter.
- 8. Design, and verify the 4-bit asynchronous counter.
- 9. Mini Project.

#### EEC 353 ELECTRONIC WORKSHOP & PCB LAB

Objective: To create interest in Hardware Technology.

- 1. Winding shop: Step down transformer winding of less than 5VA.
- 2. Soldering shop: Fabrication of DC regulated power supply
- 3. PCB Lab: (a) Artwork & printing of a simple PCB.

#### (b) Etching & drilling of PCB.

- 4. Wiring & fitting shop: Fitting of power supply along with a meter in cabinet.
- 5. Testing of regulated power supply fabricated.

Fabricate and test the audio amplifier circuit by using above power supply

## Syllabus fourth semester:

	EEC 401 ELECTRONIC CIRCUITS		310	
Unit	Торіс	Chapter/ Section	Proposed number of Lectures	
I	<b>Operational Amplifier:</b> Inverting and non-inverting configurations, difference amplifier, Effect of finite open loop gain and bandwidth on circuit performance, Large signal operation of op-amp.	2.2 to 2.6	8	
II	<b>MOSFET:</b> Review of device structure operation and V-I characteristics. Circuits at DC, MOSFET as Amplifier and switch, Biasing in MOS amplifier circuits, small-signal operation and models, single stage MOS amplifier, MOSFET internal capacitances and high frequency model, frequency response of CS amplifier	4.3 to 4.9 and 4.11	8	
III	<b>BJT:</b> Review of device structure operation and V-I characteristics, BJT circuits at DC, BJT as amplifier and switch, biasing in BJT amplifier circuit, small-signal operation and models, single stage BJT amplifier, BJT internal capacitances and high frequency model, frequency response of CE amplifier.	5.3 to 5.9	8	
IV	<b>Differential Amplifier:</b> MOS differential pair, small signal operation of the MOS differential pair, BJT differential pair, other non-ideal characteristic of the Differential amplifier (DA), DA with active load.	7.1 to 7.5	9	
V	<b>Feedback:</b> The general feed back structure, properties of negative feed back, the four basic feed back topologies, the series-shunt feedback amplifier, the series-series feedback amplifier, the shunt-shunt and shunt series feedback amplifier. <b>Oscillators:</b> Basic principles of sinusoidal oscillators, op-amp RC oscillator circuits, LC oscillator.	8.1 to 8.6 13.1 to 13.3	4+3	
Text Book: A. S. Sedra and K. C. Smith, "Microelectronic Circuits", Oxford University Press, 5th Ed				
Referen 1. 2.	<b>Ice Books:</b> Neamen D A, "Electronics Circuits", 3 <sup>rd</sup> Ed TMH Jacob Millman and Arvin Grabel, "Microelectronics", 2 <sup>nd</sup> Ed TMH			

#### THEORY SUBJECTS

	EEC 402 COMPUTER ARCHITECTURE AND ORGANIZATIO	N	310
Unit	Торіс	Chapter/	Proposed
		Section	number of Lectures
Ι	Introduction to Design Methodology: System Design - System	2.1.1, 2.1.2,	
	representation, Design Process, the gate level (revision), the register	2.1.3, 2.2.1,	
	level components and PLD (revision), register level design	2.2.2, 2.2.3	0
			0
	The Processor Level: Processor level components, Processor level	2.3.1, 2.3.2	
	design.		
II	Processor basics: CPU organization- Fundamentals, Additional features	3.1, 3.1.1,	
	Data Representation – Basic formats, Fixed point numbers, Floating	3.1.2, 3.2,	
	point numbers.	3.2.1, 3.2.2,	8
	Instruction sets – Formats, Types, Programming considerations.	3.2.3, 3.3.1,	
		3.3.2, 3.3.3	
111	Datapath Design: Fixed point arithmetic – Addition and subtraction,	4.1.1, 4.1.2,	
	Multiplication and Division, Floating point arithmetic, pipelining.	4.1.3, 4.2.1,	6
		4.2.2, 4.3.1,	
IV	Control Design: basic concents introduction bardwired control Micro	4.3.2	
1 V	control Design. basic concepts – introduction, nardwhed control, where	5.1.1, 5.1.2,	
	unit Dinalina control instruction pinalinas, pinalina performance	5.1.5, 5.2.1, 5.2.2	Q
	unit, i ipenne control- instruction pipennes, pipenne performance.	5.2.2, 5.2.3, 5.2.3, 5.3.1	0
		533	
V	Memory organization: Multi level memories Address translation	621 622	10
•	Memory allocation Caches – Main features Address mapping structure	623 631	10
	vs performance System Organisation. Communication methods- basic	631 632	
	concepts, bus control.	6.3.3. 7.1.1.	
		7.1.2	
	Introduction to 8085	Teachers	2
		choice	
Text Bo	ok: John P Hayes "Computer Architecture and Organisation" McGraw Hilll	3 <sup>rd</sup> Edition	
Referen	ce Books: M Morris Mano, "Computer System Architecture" PHI 3 <sup>rd</sup> Edition	n	

EEC 403 ELECTRONIC INSTRUMENTATION AND MEASUREMENTS						
Unit	Торіс	Chapter/	Proposed			
		Section	number of			
I	Unit dimensions and standards: Scientific notations and metric prefixes	11 to 17	Lectures			
1	SI electrical units SI temperature scales Other unit systems dimension	1.1 10 1.7				
	and standards					
	Measurement Errors: Gross error systematic error absolute error and	2.1 to 2.5				
	relative error accuracy precision resolution and significant figures	2.1 10 2.5	8			
	Measurement error combination basics of statistical analysis					
	PMMC instrument, galvanometer, DC ammeter, DC voltmeter, series	3.1 to 3.4				
	ohm meter.					
II	Transistor voltmeter circuits, AC electronic voltmeter, current	4.1, 4.2, 4.4,				
	measurement with electronic instruments, multimeter probes	4.5, 4.7	0			
	Digital voltmeter systems, digital multimeters, digital frequency meter	6.1 to 6.3	8			
	system					
III	Voltmeter and ammeter methods, Wheatstone bridge, low resistance	7.1, 7.3, 7.4,				
	measurements, low resistance measuring instruments	7.5	8			
	AC bridge theory, capacitance bridges, Inductance bridges, Q meter	8.2 to 8.4, 8.9				
IV	CRO: CRT, wave form display, time base, dual trace oscilloscope,	9.1, 9.3, 9.4,				
	measurement of voltage, frequency and phase by CRO, Oscilloscope	9.5, 9.7, 9.9,				
	probes, Oscilloscope specifications and performance.	9.12	8			
	Delay time based Oscilloscopes, Sampling Oscilloscope, DSO, DSO	10.1, 10.3,				
	applications	10.4, 10.5				
V	Instrument calibration: Comparison method, digital multimeters as	12.1, 12.2,				
	standard instrument, calibration instrument	12.3	8			
	Recorders: X-Y recorders, plotters	13.2, 13.4				
Text Bo	<b>ok:</b> David A. Bell, "Electronic Instrumentation and Measurements", 2 <sup>nd</sup> Ed.,	PHI, New Delhi	2008.			
Referen	ce Books:					
1.	Oliver and Cage, "Electronic Measurements and Instrumentation", TMH, 20	)09.				
2.	Alan S. Morris, "Measurement and Instrumentation Principles", Elsevie	er (Buterworth H	eınmann),			
	2008.					

	EEC 404 SIGNALS AND SYSTEMS		310
Unit	Topics	Chapter/	Proposed
No.		Section	number of
Ι	Signals: Definition, types of signals and their representations:	1.1 to 1.5	6
	continuous-time/discrete-time, periodic/non-periodic, even/odd,		
	energy/power, deterministic/ random, one-dimensional/multi-		
	dimensional; commonly used signals (in continuous-time as well as in		
	discrete-time): unit impulse, unit step, unit ramp (and their inter-		
	relationships), exponential, rectangular pulse, sinusoidal; operations on		
	continuous-time and discrete-time signals (including transformations		
	of independent variables).		
II	Laplace-Transform (LT) and Z-transform (ZT):	2.1 to 2.15	3+5
	(i) One-sided LT of some common signals, important theorems and		
	properties of LT, inverse LT, solutions of differential equations		
	using LT, Bilateral LT, Regions of convergence (ROC)		
	(ii) One sided and Bilateral Z-transforms, ZT of some common		
	signals, ROC, Properties and theorems, solution of difference		
	equations using one-sided ZT, s- to z-plane mapping		
III	Fourier Transforms (FT):		6+4
	(i) Definition, conditions of existence of FT, properties, magnitude	4.1 4.11;	
	and phase spectra. Some important FT theorems, Parseval's	<i>,</i>	
	theorem. Inverse FT, relation between LT and FT		
	(ii) Discrete time Fourier transform (DTFT) inverse DTFT	5 1 to 5 7	
	convergence properties and theorems Comparison between	0.1.00.0.1	
	continuous time FT and DTFT		
IV	<b>Systems:</b> Classification linearity time-invariance and causality	7.1 to $7.12$	8
1,	impulse response, characterization of linear time-invariant (LTI)	/.1 00 /.12,	Ũ
	systems, unit sample response, convolution summation, step response		
	of discrete time systems, stability.		
	convolution integral, co-relations, signal energy and energy spectral	0.2, 0.6 to 0.8	
	density, signal power and power spectral density, properties of power	9.2, 9.0 10 9.0	
V	spectral density,	0106.00	10
V	Time and frequency domain analysis of systems	8.1-8.6; 8.8	10
	Analysis of first order and second order systems, continuous-time (C1)		
	zeros block diagram representations: discrete-time system functions		
	block diagram representation, illustration of the concepts of system		
	bandwidth and rise time through the analysis of a first order CT low		
	pass filter		
Text Bool	c: P. Ramakrishna Rao, `Signal and Systems' 2008 Ed., Tata McGra	w Hill, New Delhi	
Reference	Books:	2224	
	'hi-Tsong Chen, 'Signals and Systems', 3 <sup>rd</sup> Ed., Oxford University P:	ress, 2004	nd Ed
2. V	. Oppenneim, A.S. whisky and S. Hamid Nawao, Signals & System, Pe	arson Education, 2	Ea.,
2	005.		

#### LABOROTARY

#### EEC 451 ELECTRONICS ENGINEERING LAB II

**Objective** -To design and implement the circuits to gain knowledge on performance of the circuit and its application.

- 1. **Measurement of Operational Amplifier Parameters-**Common Mode Gain, Differential Mode Gain, CMRR, Slew Rate.
- 2. Applications of Op-amp- Op-amp as summing amplifier, Difference amplifier, Integrator and differentiator
- 3. **Field Effect Transistors**-Single stage Common source FET amplifier –plot of gain in dB Vs frequency, measurement of, bandwidth, input impedance, maximum signal handling capacity (MSHC) of an amplifier
- 4. **Bipolar Transistors-** Design of single stage RC coupled amplifier –design of DC biasing circuit using potential divider arrangement –Plot of frequency Vs gain in dB. Measurement of bandwidth of an amplifier, input impedance and Maximum Signal Handling Capacity of an amplifier.
- 5. Two stage Amplifier. Plot of frequency Vs gain. Estimation of Q factor, bandwidth of an amplifier
- 6. **Common Collector Configuration-Emitter Follower** (using Darlington pair)-Gain and input impedance measurement of the circuit.
- 7. Power Amplifiers-Push pull amplifier in class B mode of operation -measurement of gain.
- 8. **Differential Amplifier** –Implementation of transistor differential amplifier .Non ideal characteristics of differential amplifier
- 9. Oscillators Sinusoidal Oscillators- (a) Wein bridge oscillator (b) phase shift oscillator
- 10. **Simulation of Amplifier** circuits studied in the lab using any available simulation software and measurement of bandwidth and other parameters with the help of simulation software.

#### EEC 452 DIGITALLAB II

- 1. TTL Transfer Characteristics and TTL IC Gates.
- 2. CMOS Gate Transfer Characteristics.
- 3. Implementation of a 3-bit SIPO and SISO shift registers using flip-flops.
- 4. Implementation of a 3-bit PIPO and PISO shift registers using flip-flops.
- 5. Design of Seven segment display driver for BCD codes.
- 6. BCD Adders & Subtractors
- 7. A L U
- 8. 8085 Assembly Language Programming

#### EEC 453 MEASUREMENT LAB

- 1. Study of semiconductor diode voltmeter and its us as DC average responding AC voltmeter .
- 2. Study of L.C.R. bridge and determination of the value of the given components.
- 3. Study of distortion factor meter and determination of the % distortion of the given oscillator.
- 4. Study of the transistor tester and determination of the parameters of the given transistors.
- 5. Study of the following transducer (i) PT-100 trans (ii) J- type trans. (iii) K-type trans (iv) Presser trans
- 6. Measurement of phase difference and frequency using CRO (lissajous figure)
- 7. Measurement of low resistance Kelvin's double bridge.
- 8. Radio Receiver Measurements

## Syllabus fifth semester:

### THEORY SUBJECTS

(Revised)			310	
EEC 501 INTEGRATED CIRCUITS				
Unit	Торіс	Chapter/	Proposed	
		From Text [1]	Lectures	
Ι	Analog Integrated circuit Design: an overview: Current Mirrors using BJT	5.6, 6.4, 6.5		
	and MOSFETs, Simple current Mirror, Base current compensated current			
	Mirror, Wilson and Improved Wilson Current Mirrors, Wildiar Current source			
	The 741 IC Op-Amp: Bias circuit, short circuit protection circuitry, the input	10.1-10.6	8	
	stage, the second stage, the output stage, and device parameters; DC Analysis of			
	741: Small Signal Analysis of input stage, the second stage, the output stage; Gain Frequency Response of 741: a Simplified Model Slew Rate Relationship			
	Between ft and SR			
II	Linear Applications of IC op-amps: An Overview of Op-Amp (ideal and non	2.2-2.7		
	ideal) based Circuits V-I and I-V converters, generalized impedance converter,			
			0	
	Filters: First and second order LP, HP, BP BS and All pass active filters, KHN,		8	
	Tow-Thomas and State Variable Biquad filters; Sinusoidal oscillators	11.4, 11.7,		
		12.1, 12.2		
III	Digital Integrated Circuit Design-An Overview: CMOS Logic Gate Circuits:	13.2-13.3		
	Basic Structure CMOS realization of Inverters, AND, OR, NAND and NOR			
	Gates			
	Latches and Flip flops: The Latch, The SR Flip-flop, CMOS Implementation of		8	
	SR Flip-flops, A Simpler CMOS Implementation of the Clocked SR Flip-flop,	13.7		
	D Flip-flop Circuits.			
IV	Non-Linear applications of IC On-amps. Log-Apti Log Amplifiers Precision	121 124		
1.4	Rectifiers, Peak Detectors, Simple and Hold Circuits, Analog Multipliers and	12.5 12.9		
	their applications. Op-amp as a comparator, Zero crossing detector, Schmitt			
	Trigger, Astable multivibrator, Monostable multivibrator, Generation of		8	
V	D/A and A/D converters	10.9-10.11	8	
	<b>Integrated Circuit Timer:</b> The 555 Circuit Implementing a Monostable			
	Multivibrator Using the 555 IC, Astable Multivibrator Using the 555 IC.	12.7		
	<b>Phase locked loops (PLL):</b> Ex-OR Gates and multipliers as phase detectors, Plack Diagram of IC PLL. Working of PLL and Applications of PLL	6.5 of Ref		
	Block Diagram of IC I EE, working of I EE and Applications of I EE.			
Text Bo	ok:	L		
[1] Sedra	a and Smith, "Microelectronic Circuits", 4 <sup>th</sup> Edition, Oxford University Press.			
Reference [2] Mick	ce Books: (active books) Applications and Design with Apalog Integrated Circuits' PHI 2 <sup>nd</sup> Edn	2006		
[2] Wilch	[3] Jacob Milliman and Arvin Grabel, "Microelectronics", 2 <sup>nd</sup> Edition, TMH, 2008.			

EEC 502 PRINCIPLES OF COMMUNICATIONS			
Unit	Торіс	Chapter/ Section	Proposed number of Lectures
I	Introduction: Overview of Communication system, Communication channels Need for modulation, Baseband and Pass band signals, Amplitude Modulation: Double side band with Carrier (DSB-C), Double side band without Carrier, Single Side Band Modulation, DSB-SC, DSB-C, SSB Modulators and Demodulators, Vestigial Side Band (VSB), Quadrature Amplitude Modulator, Radio Transmitter and Receiver.	1.1, 3.1, 3.2, 3.3, 3.4, 3.5, 3.6	10
II	Angle Modulation, Tone Modulated FM Signal, Arbitrary Modulated FM Signal, FM Modulators and Demodulators, Approximately Compatible SSB Systems, Stereophonic FM Broadcasting, Examples Based on Mat Lab.	4.1-4.6	8
III	Pulse Modulation Digital Transmission of Analog Signals: Sampling Theorem and its applications, Pulse Amplitude Modulation (PAM), Pulse Width Modulation, Pulse Position Modulation. Their generation and Demodulation, Digital Representation of Analog Signals, Pulse Code Modulation (PCM), PCM System, Issues in digital transmission: Frequency Division Multiplexing, Time Division Multiplexing ,Line Coding and their Power Spectral density, T1 Digital System, TDM Hierarchy,.	5.1-5.5	8
IV	Differential Pulse Code Modulation, Delta Modulation. Adaptive Delta Modulation, Voice Coders, Sources of Noises, Frequency domain representation of Noise, Super position of Noises, Linear filtering of Noises ,Mathematical Representation of Noise,	5.6-5.7 7.1-7.5	7
V	Noise in Amplitude Modulation: Analysis ,Signal to Noise Ratio, Figure of Merit ,Noise in Frequency Modulation: Pre emphasis ,De Emphasis and SNR Improvement, Phase Locked Loops Analog and Digital	8.1-8.3 9.1, 9.2,9.4, 9.6, 10.1- 10.3	7
<ul> <li>Text Book:</li> <li>1. H. Taube, D L Schilling, Goutom Saha, "Principles of Communication", 3<sup>rd</sup> Edition, Tata McGraw-Hill Publishing Company, Ltd</li> </ul>			
Referen	ice Books:		
1. B.P. Lathi, "Modern Digital and Analog communication Systems", 3 <sup>rd</sup> Edition, Oxford University Press, 2009.			
1.	Simon Haykin, "Communication Systems",4 <sup>th</sup> Edition, Wiley India.		
2.	2. H. P. HSU & D. Mitra , "Analog and Digital Communications", 2 <sup>nd</sup> Edition, Tata McGraw-Hill Publishing Company Ltd.		

EEC- 503 MICROPROCESSORS			
Unit	Торіс	Chapter/	Proposed
		Section	number of Lectures
Ι	Introduction to Microprocessor, Microprocessor architecture and its operations.	1.1.3.1.3.2.	Leetures
_	Memory. Input & output devices. Logic devices for interfacing. The 8085 MPU.	3.3. 3.5. 4.1.	8
	Example of an 8085 based computer, Memory interfacing.	4.2, 4.3,	-
II	Basic interfacing concepts, Interfacing output displays, Interfacing input	5.1, 5.2, 5.3,	
	devices, Memory mapped I/O, Flow chart symbols, Data Transfer operations,	5.4, 6.1, 6.2,	0
	Arithmetic operations, Logic Operations, Branch operation, Writing assembly	6.3, 6.4,	8
	language programs, Programming techniques: looping, counting and indexing.	6.5, 7.1	
III	Additional data transfer and 16 bit arithmetic instruction, Arithmetic operations	7.2, 7.3, 7.4,	
	related to memory, Logic operation: rotate, compare, counter and time delays,	7.5, 8.1, 8.2,	
	Illustrative program: Hexadecimal counter, zero-to-nine, (module ten) counter,	8.3, 8.4, 8.5,	0
	generating pulse waveforms, debugging counter and time delay, Stack,	9.1, 9.2, 9.3,	0
	Subroutine, Restart, Conditional call and return instructions, Advance	9.4, 12.1,	
	subroutine concepts, The 8085 Interrupts, 8085 vector interrupts.	12.2	
IV	Program: BCD-to-Binary conversion, Binary-to-BCD conversion, BCD-to-	10.1, 10.2,	
	Seven segment code converter, Binary-to-ASCII and ASCII-to-Binary code	10.3, 10.4,	
	conversion, BCD Addition, BCD Subtraction, Introduction to Advance	10.5, 10.6,	8
	instructions and Application, Multiplication, Subtraction with carry.	10.7, 10.8,	
		10.9	
V	8255 Programmable peripheral interface, interfacing keyboard and seven	15.1, 15.2,	
	segment display, 8254 (8253) programmable interval timer, 8259A	15.4, 15.5,	
	programmable interrupt controller, Direct Memory Access and 8237 DMA	15.6,	8
	controller.		0
	Introduction to 8086 microprocessor: Architecture of 8086 (Pin diagram,	2.11*, 2.12*	
	Functional block diagram, Register organization).		
Text Bo	ok:		-th
1.	Ramesh Gaonkar, "Microprocessor Architecture, Programming, and Applications v	vith the 8085", 3	5 <sup>th</sup> Edition,
	Penram International Publication (India) Pvt. Ltd.		
2.	* Douglas V. Hall, "Microprocessors and Interfacing", 2 <sup>nd</sup> Edition, TMH, 2006.		

Reference Book: Kenneth L. Short, "Microprocessors and programmed Logic", 2<sup>nd</sup> Ed, Pearson Education Inc.

EEC 504 ANTENNA AND WAVE PROPAGATION			
Unit	Tonia	Chapter/	Proposed
Unit	Topic	Section	number of
		Section	Lectures
Ι	Antennas Basics	2.1 to 2.12,	
	Introduction, Basic Antenna Parameters, Patterns, Beam Area (or Beam Solid	2.18 to 2.20	
	Angle) $\Omega A$ , Radiation Intensity, Beam Efficiency, Directivity D and Gain G,	4.2 4 4 7	
	Directivity and Resolution, Antenna Apertures, Effective Height, The radio	4.3 to 4.7	8
	Communication link, Fields from Osciliating Dipole, Single-to-Noise Detic(CND) Antenna Temperature Antenna Impedance Deterded Detertial Fer		
	Field due to on alternating auront alement. Dever radiated by a surrent alement		
	Field variation due to sinusoidal current distribution		
II	Point Sources and Their Arrays	5 1 to 5 5	
11	Introduction Point Source Power Theorem and its Application to an Isotropic	$5.1 \pm 5.5$ 5.9 to 5.11	
	Source Radiation Intensity Arrays of Two Isotronic Point Sources Non-	5 13 5 15	
	isotropic but Similar Point Sources and the Principle of Pattern Multiplication	62 to $66$	
	Pattern Synthesis by Pattern Multiplication. Linear Arrays of n Isotropic Point	6.10. 6.11.	
	Sources of Equal Amplitude and Spacing, Linear Broadside Arrays with Non-	6.14 to 6.15.	
	uniform Amplitude Distributions. General Considerations.	6.16 to 6.17,	10
	Electric Dipoles, Thin Liner Antennas and Arrays of Dipoles and Apertures	6.21	10
	The Short Electric Dipole, The Fields of a Short Dipole, Radiation Resistance of		
	Short Electric Dipole, Thin Linear Antenna, Radiation Resistance of $\lambda/2$ Antenna,		
	Array of Two Driven $\lambda/2$ Elements: Broadside Case and End-Fire Case,		
	Horizontal Antennas Above a Plane Ground, Vertical Antennas Above a Plane		
	Ground, Yagi-Uda Antenna Design, Long-Wire Antennas, folded Dipole		
	Antennas.		
III	The Loop Antenna. Design and its Characteristic Properties, Application of Loop	6.23,6.24,7.4,	
	Antennas, Far Field Patterns of Circular Loop Antennas with Uniform Current,	/.5,/.13,/.19,	7
	Slot Antennas, Horn Antennas, Helical Antennas, The Log-Periodic Antenna,	8	
IV/	Micro strip Antennas	0.20.205 to	
1 V	Flat Sheet Deflectors, Corner Deflectors, The Derabola General Droperties, A	9.2, 9.3, 9.5 10	
	comparison Between Parabolic and Corner Reflectors. The Paraboloidal	9.9, 9.10, 10, 10, 117, 14	
	Reflector Patterns of Large Circular Apertures with Uniform Illumination	11.7, 14	
	Reflector Types(summarized) Feed Methods for Parabolic Reflectors		8
	Antenna Measurements		
	Introduction, Antenna Measurement ranges, Radiation pattern Measurements,		
	Gain and Directivity Measurements, Spectrum Analyzer		
V	Ground Wave Propagation	23.2 to 23.3,	
	Plane Earth Reflection, Space Wave and Surface Wave,	24.1 to 24.4,	
	Space Wave Propagation	25.1 to 25.6,	
	Introduction, Field Strength Relation, Effects of Imperfect Earth, Effects of	25.8, 25.12	
	Curvature of Earth,		
	Sky wave Propagation		10
	Introduction structural Details of the ionosphere, Wave Propagation Mechanism,		
	Refraction and Reflection of Sky Waves by ionosphere, Ray Path, Critical		
	Frequency, MUF, LUF, UF, Virtual Height and Skip Distance, Relation		
	Between MUF and the Skip Distance, Multi-Hop Propagation, Wave		
Toy D	Cilial activities	Nove Droposti	n" Fourth
Edition	Tata McGraw Hill 2010 Special Indian Edition	wave riopagatio	л, rouin
Lattion	, rum mostuw min, 2010 special indian Edition.		

#### **Reference Books:**

- 1. A .R. Harish, M. Sachidananda, "Antennas and Wave Propagation", Oxford University Press, 2009.
- 2. Jordan Edwards C. and Balmain, Keith G."Electromagnetic Waves and Radiating Systems", PHI.
- 3. A. Das, Sisir K. Das, "Microwave Engineering", Tata McGraw Hill.

Uni	FIC 501 CONTROL SYSTEM I	Text Book/	Proposed		
Om		Chapter	number of		
			Lectures		
Ι	Basic Components of a control system, Feedback and its effect, types of	1.1 to 1.3			
	feedback control systems.				
	Block diagrams and signal flow graphs,	3.1 to 3.2	8		
	Modeling of Physical systems: electrical networks, mechanical systems	4.1 to 4.6	0		
	elements, equations of mechanical systems, sensors and encoders in control				
	systems, DC motors in control systems.				
II	State-Variable Analysis: Vector matrix representation of state equation, state	5.1 to 5.6			
	transition matrix, state-transition equation, relationship between state equations		0		
	and high-order differential equations, relationship between state equations and		0		
	transfer functions.				
III	Time domain Analysis of Control Systems: Time response of continuous data	7.1 to 7.6			
	systems, typical test signals for the time response of control systems, the unit		0		
	step response and time-domain specifications, Steady-State error, time response		0		
	of a first order system, transient response of a prototype second order system				
IV	Stability of Linear Control Systems: Bounded-input bounded-output stability-	6.1 to 6.5			
	continuous data systems, zero-input and asymptotic stability of continuous data		8		
	systems, methods of determining stability, Routh Hurwitz criterion.				
V	Frequency Domain Analysis: $M_r$ (resonant peak) and $\omega_r$ (resonant frequency)	9.1to 9.11			
	and bandwidth of the prototype Second order system, effects of adding a zero to				
	the forward path, effects of adding a pole to the forward path, Nyquist stability		10		
	criterion, relative stability: gain margin and phase margin, stability analysis with				
	the Bode plot				
]	Text Book: B.C. Kuo & Farid Golnaraghi, "Automatic Control Systems", 8th Edition, J	ohn Wiley India	a, 2008.		
]	Reference Books:				
1.	1. William A. Wolovich, "Automatic Control Systems", Oxford University Press, 2010.				
2.	Joseph J. Distefano III, Allen R. Stubberud, Ivan J. Williams, "Control Systems" Schau	ums Outlines Se	ries, 3 <sup>rd</sup>		
	Edition, Tata McGraw Hill, Special Indian Edition 2010.				

3. I. J. Nagrath & M. Gopal, "Control System Engineering", New Age International Publishers

#### LABOROTARY

#### EEC 551 INTEGRATED CIRCUITS LAB

**Objective:** - To design and implement the circuits to gain knowledge on performance of the circuit and its application. These circuits should also be simulated on Pspice.

- 1. Log and antilog amplifiers.
- 2. Voltage comparator and zero crossing detectors.
- 3. Second order filters using operational amplifier for
  - a. Low pass filter of cutoff frequency 1 KHz.
  - b. High pass filter of frequency 12 KHz.
  - c. Band pass filter with unit gain of pass band from 1 KHz to 12 KHz.
- 4. Wien bridge oscillator using operational amplifier.
- 5. Determine capture range; lock in range and free running frequency of PLL.
- 6. Voltage regulator using operational amplifier to produce output of 12V with maximum load current of 50 mA.
- 7. A/D and D/A convertor.
- 8. Voltage to current and current to voltage convertors.
- 9. Function generator using operational amplifier (sine, triangular & square wave)
- 10. Astable and monostable multivibrator using IC 555.

#### EEC 552 COMMUNICATION LAB-I

- 1. To study DSB/ SSB amplitude modulation & determine its modulation factor & power in side bands.
- 2. To study amplitude demodulation by linear diode detector
- 3. To study frequency modulation and determine its modulation factor
- 4. To study PLL 565 as frequency demodulator.
- 5. To study sampling and reconstruction of Pulse Amplitude modulation system.
- 6. To study the Sensitivity, Selectivity, and Fidelity characteristics of super heterodyne receiver.
- 7. To study Pulse Amplitude Modulation
  - a. using switching method
  - b. by sample and hold circuit
- 8. To demodulate the obtained PAM signal by 2nd order LPF.
- 9. To study Pulse Width Modulation and Pulse Position Modulation.
- 10. To plot the radiation pattern of a Dipole, Yagi-uda and calculate its beam width.
- 11. To plot the radiation pattern of Horn, Parabolic & helical antenna. Also calculate beam width & element current.
- 12. Design and implement an FM radio receiver in 88-108 MHz.

#### EEC 553 MICROPROCESSOR LAB

- 1. Write a program using 8085 Microprocessor for Decimal, Hexadecimal addition and subtraction of two Numbers.
- 2. Write a program using 8085 Microprocessor for addition and subtraction of two BCD numbers.
- 3. To perform multiplication and division of two 8 bit numbers using 8085.
- 4. To find the largest and smallest number in an array of data using 8085 instruction set.
- 5. To write a program to arrange an array of data in ascending and descending order.
- 6. To convert given Hexadecimal number into its equivalent ASCII number and vice versa using 8085 instruction set.
- 7. To write a program to initiate 8251 and to check the transmission and reception of character.
- 8. To interface 8253 programmable interval timer to 8085 and verify the operation of 8253 in six different modes.
- 9. To interface DAC with 8085 to demonstrate the generation of square, saw tooth and triangular wave.
- 10. Serial communication between two 8085 through RS-232 C port.

Note :- In addition, Institutes may include two more experiments based on the expertise.

#### EIC 551 CONTROL SYSTEM LAB

- 1. DC SPEED CONTROL SYSTEM
- (a) To study D.C. speed control system on open loop and close loop.
- (b) To study of Transient performance, another time signal is added at the input of control Circuit.
- (c) To study how eddy current breaking is being disturbance rejected by close and open loop.
- 2. DC MOTOR POSITION CONTROL
- (a) To study of potentiometer displacement constant on D.C. motor position control.
- (b) To study of D. C. position control through continuous command.
- (c) To study of D.C. position control through step command.
- (d) To study of D.C. position control through Dynamic response.
- 3. AC MOTOR POSITION CONTROL
- (a) To study of A.C. motor position control through continuous command.
- (b) To study of error detector on A.C. motor position control through step command.
- (c) To study of A.C. position control through dynamic response.
- 4. MAGNETIC AMPLIFIER
- (a) To study Input / Output characteristic of a magnetic amplifier in mode (i) Saturable Reactor, (ii) Self Saturable Reactor.
- 5. SYNCHRO TRANSMITTER / RECEIVER
- (a) To study of Synchro Transmitter in term of Position v/s Phase and voltage magnitude with respect to Rotor Voltage Magnitude/Phase.
- (b) To study of remote position indication system using Synchro-transmitter/receiver.
- 6. PID CONTROLLER
- (a) To observe open loop performance of building block and calibration of PID Controls.
- (b) To study P, PI and PID controller with type 0 system with delay.
- (c) To study P, PI and PID controller with type 1 system.
- 7. LEAD LAG COMPENSATOR
  - (a) To study the open loop response on compensator.
  - (b) Close loop transient response.
- 8. LINEAR SYSTEM SIMULATOR
  - (a) Open loop response
    - (i) Error detector with gain, (ii) Time constant, (iii) Integrator
    - (b) Close loop system
    - (I) First order system (II) Second order system (III) Third order system
- 9. Introduction to MATLAB (Control System Toolbox), Implement at least any two experiment in MATLAB.
  - a. Different Toolboxes in MATLAB, Introduction to Control Systems Toolbox.
  - b. Determine transpose, inverse values of given matrix.
  - c. Plot the pole-zero configuration in s-plane for the given transfer function.
  - d. Determine the transfer function for given closed loop system in block diagram representation.
  - e. Plot unit step response of given transfer function and find peak overshoot, peak time.
  - f. Plot unit step response and to find rise time and delay time.
  - g. Plot locus of given transfer function, locate closed loop poles for different values of k.
  - h. Plot root locus of given transfer function and to find out S, Wd, Wn at given root & to discuss stability.
  - i. Plot bode plot of given transfer function.
  - j. Plot bode plot of given transfer function and find gain and phase margins
  - k. Plot Nyquist plot for given transfer function and to compare their relative stability
  - 1. Plot the Nyquist plot for given transfer function and to discuss closed loop stability, gain and phase margin.

Syllabus sixth semester:

#### **THEORY SUBJECTS**

EEC 601 DIGITAL COMMUNICATIONS			310
Unit	Торіс	Chapter/	Proposed
		Section	Lectures
Ι	Digital Data transmission, Line coding review, Pulse shaping, Scrambling, Digital receivers, Eye diagram, Digital carrier system, Method of generation and detection of coherent & non-coherent binary ASK, FSK & PSK, Differential phase shift keying, quadrature modulation techniques. (QPSK and MSK ),M-ary Digital carrier Modulation.	7.1-7.10, 10.11	10
Π	Concept of Probability, Random variable, Statistical averages, Correlation, Sum of Random Variables, Central Limit Theorem, Random Process, Classification of Random Processes, Power spectral density, Multiple random processes,	8.1-8.7, 9.1-9.4	8
III	Performance Analysis of Digital communication system: Optimum linear Detector for Binary polar signaling, General Binary Signaling, Coherent Receivers for Digital Carrier Modulations, Signal Space Analysis of Optimum Detection, Vector Decomposition of White Noise Random processes, General Expression for Error Probability of optimum receivers,	10.1-10.7	8
IV	Spread spectrum Communications: Frequency Hopping Spread Spectrum(FHSS) systems, Direct Sequence Spread Spectrum, Code Division Multiple Access of DSSS, Multiuser Detection, OFDM Communications	11.1- 11.7,12.7	6
V	Measure of Information, Source Encoding, Error Free Communication over a Noisy Channel capacity of a discrete and Continuous Memory less channel Error Correcting codes: Hamming sphere, hamming distance and Hamming bound, relation between minimum distance and error detecting and correcting capability, Linear block codes, encoding & syndrome decoding; Cyclic codes, encoder and decoders for systematic cycle codes; convolution codes, code tree & Trellis diagram, Viterbi and sequential decoding, burst error correction, Turbo codes.	13.1-13.5, 14.1-4.4, 14.6-14.11	8
Text Bo	OK:		

1. B.P. Lathi, "Modern Digital and Analog communication Systems", 4<sup>th</sup> Edition, Oxford University Press, 2010.

#### **Reference Books:**

1. H. Taub, D L Schilling, Goutom Saha, "Principles of Communication", 3<sup>rd</sup> Edition, Tata McGraw-Hill Publishing Company Ltd.

 John G. Proakis, "Digital Communications", 4<sup>th</sup> Edition, McGraw-Hill International.
 Simon Haykin, "Communication Systems", 4<sup>th</sup> Edition, Wiley India.
 H P HSU & D Mitra, "Analog and Digital Communications", 2<sup>nd</sup> Edition, Tata McGraw-Hill Publishing Company Ltd.

EEC 602 DIGITAL SIGNAL PROCESSING			310
Unit	Торіс	Chapter/ Section	Proposed
			number of
т	Desting the Constant Sector of Later Action direct Company line to the Company of	414546	Lectures
1	<b>Realization of Digital Systems:</b> Introduction, direct form realization of	4.1, 4.5, 4.6,	8
	IIR systems, cascade realization of an IIR systems, parallel form	4.7, 4.8	
	realization of an IIR systems, Ladder structures: continued fraction		
	expansion of $H(z)$ , example of continued fraction, realization of a ladder		
	structure, example of a ladder realization.		
II	Design of Infinite Impulse Response Digital Filters: Introduction to	5.2-5.6	8
	Filters, Impulse Invariant Transformation, Bi-Linear Transformation, All-		
	Pole Analog Filters: Butterworth and Chebyshev, Design of Digital		
	Butterworth and Chebyshev Filters		
III	Finite Impulse Response Filter Design: Windowing and the	6.2-6.5	8
	Rectangular Window, Other Commonly Used Windows, Examples of		
	Filter Designs Using Windows, The Kaiser Window		
IV	Discrete Fourier Transforms: Definitions, Properties of the DFT,	7.1-7.4	8
	Circular Convolution, Linear Convolution		
V	Fast Fourier Transform Algorithms: Introduction, Decimation -In	8.1-8.4	8
	Time(DIT) Algorithm, Computational Efficiency, Decimation in		
	Frequency(DIF) Algorithm		
Text Books: Johnny R. Johnson, "Digital Signal Processing", PHI Learning Pvt Ltd., 2009.			
Referen	ce Books:		
1.	John G Prokias, Dimitris G Manolakis, "Digital Signal Processing", Pearson	Education.	
2.	Oppenheim & Schafer, "Digital Signal Processing" PHI		

EEC 603 MICROWAVE ENGINEERING			310
Unit	Торіс	Chapter/ Section	Proposed number of Lectures
Ι	Rectangular Wave Guide: Field Components, TE, TM Modes, Dominant $TE_{10}$ mode, Field Distribution, Power, Attenuation. Circular Waveguides: TE, TM modes. Wave Velocities, Micro strip Transmission line (TL), Coupled TL, Strip TL, Coupled Strip Line, Coplanar TL, Microwave Cavities,	4.1-4-3,11.0- 11.3	8
II	Scattering Matrix , Passive microwave devices: Microwave Hybrid Circuits. , Terminations, Attenuators, Phase Shifters, Directional Couplers: Two Hole directional couplers, S Matrix of a Directional coupler, Hybrid Couplers, Microwave Propagation in ferrites, Faraday Rotation, Isolators, Circulators. S parameter analysis of all components.	4.4-4.6	8
III	Microwave Tubes: Limitation of Conventional Active Devices at Microwave frequency, Two Cavity Klystron, Reflex Klystron, Magnetron, Traveling Wave Tube, Backward Wave Oscillators: Their Schematic, Principle of Operation, Performance Characteristic and their applications.	9.0-9.5, 10.0- 10.2	8
IV	Solid state amplifiers and oscillators: Microwave Bipolar Transistor, Microwave tunnel diode, Microwave Field-effect Transistor, Transferred electron devices, Avalanche Transit –time devices: IMPATT Diode, TRAPPAT Diode,	5.0- 5.1,5.3,6.0- 6.1,7.0-7.3	10
V	Microwave Measurements: General set up of a microwave test bench, Slotted line carriage, VSWR Meter, microwave power measurements techniques, Crystal Detector, frequency measurement, wavelength measurements, Impedance and Refection coefficient, VSWR, Insertion and attenuation loss measurements, measurement of antenna characteristics, microwave link design.	14.1-14.4 (Book 2)	8
<b>Text Books:</b>			
<ol> <li>A. Das and S. K. Das, "Microwave Engineering", TMH.</li> </ol>			
Referen	ce Books:		
1. R.E Collin, "Foundation for Microwave Engineering ", 2 <sup>nd</sup> Ed., John Wiley India.			

EEC 604 INTRODUCTION TO ELECTRIC DRIVES			310
Unit	Торіс	Chapter/	Proposed
		Section	number of Lectures
Ι	Thyristor: Principles and Characteristics	1.1-1.16	0
	Gate Triggering Circuits	2.1-2.10	8
II	Phase Controlled Rectifiers		
	Phase Angle Control, Single-phase Half-wave Controlled Rectifier (One	4.2 - 4.4	
	quadrant), Single-phase Full-wave Controlled Rectifier (Two quadrant	4.6 - 4.8	
	Converters), Performance Factors of Line-commutated Converters, The		
	Performance Measures of Two-pulse Converters, Three phase Controlled		8
	Converters		
	Inverters: Introduction Thyristor Inverter Classification, Series	5.1 – 5.3, 5.5.	
	Inverters, Parallel Inverter, Three-phase Bridge Inverters, Three-phase	5.7-5.8	
	Bridge Inverter with Input-circuit Commutation.		
III	Choppers: Introduction, Principle of Chopper Operation, Control	6.2 – 6.5, 6.8	
	Strategies, step-up/Down Chopper, Jones Chopper		
	Cycloconverters: Introduction, The Basic Principle of Operation,	7.1 – 7.5	8
	Single-phase to Single-phase Cycloconverter, Three-phase half-wave		
	Cycloconverters, Cycloconverter Circuits for Three-phase Output		
IV	Control of D.C. Drives: Introduction, Basic Machine Equations,	12.1 - 12.10	
	Breaking Modes, Schemes for D.C. Motor Speed Control, Single-phase		
	Separately Excited Drives, Braking Operation of Rectifier Controlled		8
	Separately excited Motor, Single-phase Separately Excited Drives,		0
	Power Factor Improvement, Three-phase Separately Excited Drives,		
	D.C. Chopper Drives		
V	Control of A.C. Drives: Introduction, basic Principle of Operation,	13.1 – 13.9	
	Squirrel-cage Rotor Design, Speed Control of Induction Motors, stator		8
	Voltage Control, Variable Frequency control, Rotor Resistance Control,		0
	Slip Power Recovery Scheme, Synchronous Motor Drives		
Text Bo	ok: M.D. Singh & K. Khan chandani, "Power Electronics", Tata McGraw H	ill 1998 Edition	
Referen	ce Books: M H Rashid, "Power Electronics", 3rd Ed., Pearson Education, 20	09.	

#### Departmental Electives I:

EEC- 011 ANALOG SIGNAL PROCESSING				
Unit	Topic	Chapter/ Section	Proposed	
	1		number	
			of	
			Lectures	
I	Liner Analog Functions: Addition, Subtraction, Differentiation,	4.1-4.5	8	
	Integration, Impedance Transformation and Conversion	Text book 1		
II	AC/DC Signal Conversion: Signal Rectification, Peak and Valley	5.2-5.5	8	
	Detection, rms to dc Conversion, Amplitude Demodulation	Text book 1		
III	Other Nonlinear Analog Functions: Voltage Comparison, Voltage	6.1-6.6	8	
	Limiting(Clipping), Logarithmic Amplifiers, Analog Multipliers, Analog	Text book 1		
	Dividers			
IV	Continuous time op-amp RC filters: Second order LP, HP, BP, Notch and	4.2, 4.3, 4.4,	8	
	AP transfer functions, Kirwin-Huelsman-Newcomb biquad, Ackerberg-	4.5		
	Mosberg Circuits, Tow-Thomas biguad, compensated integrators,	Text book 2		
	Sallenkey Circuits, Generalized convertor, GIC biquads.			
V	Transconductance-C filters: Transconductance cells, realization of	16.1, 16.2,	8	
	resistors, integrators, amplifiers, summers and gyrators, first order and	16.3, 16.4.2		
	second order sections, Ladder design.	Text book 2		
Text Bo	oks:		•	
1.	1. Ramon Pallas-Areny, John G. Webster, "Analog Signal Processing", John Wiley& Sons			

2. R. Schaumann and M. E. Valkenberg, "Design of Analog Circuits", Oxford University Press, 2001.

	EEC 012 DATA STRUCTURE		310
Unit	Торіс	Chapter/	Proposed
		Section	number of
			Lectures
Ι	Introduction: Basic Terminology, Elementary Data Organization,		8
	Algorithm, Efficiency of an Algorithm, Time and Space Complexity,		
	Asymptotic notations: Big-Oh, time-Space trade-off, Abstract Data Types		
	(ADT)		
	Arrays: Definition, Single and Multidimensional Arrays, Representation of		
	Arrays: Row major Order, and Column Major Order, Application of arrays,		
	<b>J inked lists:</b> Array Implementation and Dynamic Implementation of Singly		
	Linked Lists, Doubly Linked List, Circularly Linked List, Operations on a		
	Linked Lists, Doubly Enneed Elst, Operations on a		
	Addition. Generalized Linked List.		
II	<b>Stacks:</b> Abstract Data Type, Primitive Stack operations: Push & Pop, Array		8
	and Linked Implementation of Stack in C, Application of stack: Prefix and		-
	Postfix Expressions, Evaluation of Postfix expression, Recursion, Tower of		
	Hanoi Problem, Simulating Recursion, Principles of recursion, Tail recursion,		
	Removal of recursion.		
	Queues: Operations of Queue: Create, Add, Delete, Full and Empty, Circular		
	queues, Array and linked implementation of queues in C, Dequeue and		
TIT	Priority Queue		0
111	Penergentation and Dynamic Bangagantation Complete Dinary Trees		8
	Algebraic Expressions Extended Binary Trees Array and Linked		
	Representation of Binary trees Tree Traversal algorithms: In-order Pre-order		
	and Post-order Threaded Binary trees Traversing Threaded Binary trees		
	Huffman algorithm.		
	, , , , , , , , , , , , , , , , , , ,		
IV	Graphs: Terminology, Sequential and linked Representations, of Graphs:		8
	Adjacency Matrices, Adjacency List, Adjacency Multi list, Graph Traversal:		
	Depth First Search and Breadth first Search, Connected Component,		
	Spanning Trees, Minimum Cost Spanning Trees: Prims and Kurskal		
	algorithm, Iransitive Closure and Shortest Path algorithm: Warshal		
V	Algorithm and Dijikstra Algorithm, introduction to Activity Networks.		0
v	Internal Sorting: Insertion Sort selection Bubble Sort Quick Sort Two		0
	Way Merge Sort Heap Sort Radix Sort Practical consideration for Internal		
	Sorting.		
	Search Trees: Binary Search Trees (BST), Insertion and Deletion in BST,		
	Complexity of search Algorithm, AVL trees, Introduction to m-way Search		
	Trees, B Trees & B+ Trees Storage Management: Garbage Collection and		
	Compaction.		
Text Boo	ok:		~ `
1.	1. Aaron M. Tenenbaum, Yedidyah Langsam and Moshe J. Augenstein "Data structures Using C and		
2	C++", PHI Lingabutz "Data Structures" Scheum's Outling Spring TMU		
Z. Reference	Properties Data Structures Schaum's Outline Series, IMH		
1	DUCKS. Horowitz and Sahani "Fundamentals of Data Structures" Galgotia Publication		
1.	rioro niz and banan, i undamentals of Data Structures, Gargotia I ubication		

EEC 013 ADVANCE SEMICONDUCTOR DEVICES			310	
Unit	Торіс	Chapter/ Section	Proposed number of Lectures	
Ι	Review of Fundamentals of Semiconductors:			
	Semiconductor Materials and their properties	3.1 to 3.8		
	Carrier Transport in Semiconductors	4.1 to 4.9	10	
	Excess Carriers in Semiconductor	5.1 to 5.7		
II	Junctions and Interfaces:			
	Description of p-n junction, Action, The Abrupt Junction, Example of an	6.1 to 6.4		
	Abrupt Junction, The linearly graded Junction. The Ideal Diode Model, Real Diodes, Temperature Dependence of I-V	7.1 to 7.5	8	
	Characteristics, High Level Injection Effects, Example of Diodes. Description of Breakdown Mechanism Zener and Avalanche	8.1,8.3,8.5,8.7		
	Breakdown in p-n Junction			
III	Majority Carrier Diodes:			
	The Tunnel Diode, The Backward Diode, The Schottkey Barrier Diode,	10.1 to 10.5	6	
	Ohmic Contacts Heterojunctions.			
IV	Microwave Diodes:			
	The Varactor Diode, The p-i-n Diode, The IMPATT Diode, TRAPATT	11.1 to 11.6		
	Diode, The BARITT Diode, Transferred Electron Devices		8	
	Optoelectronic Devices:	12.1 to 12.4	0	
	The Solar Cell, Photo detectors, Light Emitting Diodes, Semiconductor			
	Lasers.			
V	Metal Semiconductor Field Effect Transistors:	15 4 40 15 7		
	Basic Types of MESFETs, Models for I-V Characteristics of Short –	13.4 10 13.7		
	Channel MESFEIs, High Frequency Performance, MESFEIs		0	
	Structures.		8	
	MOS Transistors and the Operating Principle I V Characteristics Short	16.4 to 16.9		
	Channel Effects MOSEET Structures Charge Coupled Devices			
Text Book: M.S. Tyagi "Introduction To Semiconductor Materials And Devices." John Willy India P			Dyt I td	
Reference Books.			vi. L/u.	
1.	1. S. M. Sze, "Physics of Semiconductor Devices", 2 <sup>nd</sup> Edition, John Willy-India Pvt. Ltd.			
2.	2. B. G. Streetman and S. Banerjee, "Solid state electronics devices", 5 <sup>th</sup> Edition, PHI.			

EIC 601 MICROCONTROLLER			310	
Unit	Торіс	Chapter/	Proposed	
		Section	number of	
			Lectures	
Ι	Introduction, Microcontrollers and Embedded processors, Overview of	0.3, 1.1, 1.2,	6	
	the 8051, Inside the 8051, Addressing modes,	2.1, 5.1-5.4,		
II	Introduction to 8051 assembly programming, Assembling and running	2.2, 2.3, 2.4,	8	
	an 8051 program, The program counter and ROM space in the 8051,	2.5, 2.6, 2.7,		
	8051 data types and directives, 8051 flag bits and the PSW register,	4.1, 4.2		
	8051 register banks and stack, 8051 I/O programming, I/O bit			
	manipulation programming.			
III	Programming the 8051 timers, Counter programming, Basics of serial	9.1, 9.2,	10	
	communications, 8051 connection to RS-232, 8051 serial port	10.1, 10.2,		
	programming assembly, 8051 interrupts, Programming timer interrupts,	10.3, 11.1,		
	programming external hardware interrupts, programming the Serial	11.2, 11.3,		
	communication interrupts, Interrupts priority in the 8051,	11.4, 11.5		
IV	Interfacing with 8051: Memory address decoding 8031/51 interfacing	14.2, 14.3,	10	
	with external ROM, 8051 data memory space, LCD, Keyboard, Parallel	14.4, 12.1,		
	and Serial ADC, DAC interfacing, Sensor interfacing and Signal	12.2, 13.1,		
	Conditioning, Stepper motor and DC motor,	13.2, 13.3,		
		17.2, 17.3,		
V	Programming the 8255 and Interfacing, Introduction to Intel 8096 and	15.1, 15.2,	6	
	MC68HC11 microcontroller*.	Text Book		
		2: Ch. 3 & 4		
Text Book:				
1. Mazidi Ali Muhammad, Mazidi Gillispie Janice, and McKinlay Rolin D., "The 8051 Microcontroller				
and Embedded Systems using Assembly and C", Pearson, 2 <sup>nd</sup> Edition.				
2. Chhabra Bhupendra Singh, "Microcontrollers & its Applications" Dhanpat Rai Publishing Company				
Reference Book:				
1. Ayala Kenneth, "The 8051 Microcontroller", Cengage Learning, 3 <sup>rd</sup> Edition				
2.	Shah Satish, "8051 Microcontrollers MCS 51 Family and its variants", Oxford			
3.	Ghoshal Subrata, "8051 Microcontroller Internals, Instructions, Programming and Interfacing"			
	Pearson			

#### LABOROTARY

#### EEC 651 COMMUNICATION LAB – II

- 1. To construct a triangular wave with the help of Fundamental Frequency and its Harmonic component.
- 2. To construct a Square wave with the help of Fundamental Frequency and its Harmonic component.
- 3. Study of Pulse code modulation (PCM) and its demodulation using Bread Board.
- 4. Study of delta modulation and demodulation and observe effect of slope overload.
- 5. Study of pulse data coding techniques for NRZ formats.
- 6. Study of Data decoding techniques for NRZ formats.
- 7. Study of Manchester coding and Decoding.
- 8. Study of Amplitude shift keying modulator and demodulator.
- 9. Study of Frequency shift keying modulator and demodulator.
- 10. Study of Phase shift keying modulator and demodulator
- 11 Study of single bit error detection and correction using Hamming code.
- 12 Measuring the input impedance and Attenuation of a given Transmission Line

#### EEC-652 DIGITAL SIGNAL PROCESSING LAB

- 1. With the help of Fourier series, make a square wave from sine wave and cosine waves. Find out coefficient values.
- 2. Evaluate 4 point DFT of and IDFT of  $x(n) = 1, 0 \le n \le 3; 0$  elsewhere.
- 3. Implement the FIR Filters for 2 KHz cutoff frequency and 2 KHz bandwidth for band pass filter.
- 4. Design FIR filter using Fourier series expansion method.
- 5. Implement IIR low pass filter for a 4 KHz cutoff frequency and compare it the FIR filter with the same type use chirp as input signal.
- 6. Verify Blackman and Hamming windowing techniques for square wave as an input which window will give good results.
- 7. Implement the filter functions.
- 8. Generate DTMF sequence 1234567890\*# and observe its spectrogram.
- 9. Generate an Amplitude Modulation having side low frequencies 1200 Hz and 800 Hz. Observe and verify the theoretical FFT characteristics with the observed ones.
- 10. Generate Frequency Modulation having carrier frequencies 1 KHz and modulating frequency 200 Hz with the modulation index of 0.7. Observe and verify the theoretical FFT characteristics with the observed ones.
- 11. Generate an FSK wave form for transmitting the digital data of the given bit sequence. Predict and verify the FFT for the same one.
- 12. To study the circular convolution.

#### EEC-553 CAD OF ELECTRONICS LAB

#### **PSPICE** Experiments

- 1. (a) Transient Analysis of BJT inverter using step input.
- (b)DC Analysis (VTC) of BJT inverter with and without parameters.
- 2. (a) Transient Analysis of NMOS inverter using step input.
  - (b) Transient Analysis of NMOS inverter using pulse input.
  - (c) DC Analysis (VTC) of NMOS inverter with and without parameters.
- 3. (a) Analysis of CMOS inverter using step input.
  - (b) Transient Analysis of CMOS inverter using step input with parameters.
  - (c) Transient Analysis of CMOS inverter using pulse input.
  - (d) Transient Analysis of CMOS inverter using pulse input with parameters.
  - (e) DC Analysis (VTC) of CMOS inverter with and without parameters.
- 4. Transient & DC Analysis of NOR Gate inverter.
- 5. Transient & DC Analysis of NAND Gate.
- VHDL Experiments
- 1. Synthesis and simulation of Full Adder.
- 2. Synthesis and Simulation of Full Subtractor.
- 3. Synthesis and Simulation of 3 X 8 Decoder.
- 4. Synthesis and Simulation of 8 X 1 Multiplexer.

- 5. Synthesis and Simulation of 9 bit odd parity generator.6. Synthesis and Simulation of Flip Flop (D, and T).